Guangdong Yongyu Optoelectronics Co., Ltd



ChipLED 0805 Series 2.0*1.25*0.85mm Single Color Package



A representative image

ChipLED 0805 Red Series

Description

- These ChipLEDs are designed in an industry-standard package.
- Various LED colors are available in seven compact, single-color packages.
- The YY0805 has the industry-standard 2.0 mm \times 1.25 mm footprint, which is excellent for all-around use.
- These ChipLEDs are packaged in tape and reel with 3000 units in general per reel.
- All packages are compatible with IR reflow solder processes.
- The small size and wide viewing angle,

Features and Benefits

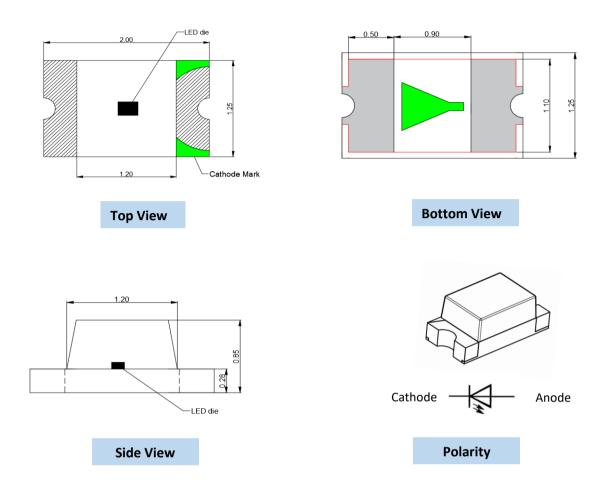
- Small size, Industry-standard footprint
- Compatible with Infrared solder process
- Compatible with automatic placement equipment
- Operating temperature range of –40°C to +85°C
- \bullet Viewing angle: 140°
- Right angle and reverse mount package available
- Various colors available
- Available in 8-mm tape, 7" reel (3000 pcs/reel), Meets EIA STD package
- Moisture sensitivity level: 3
- Halogen-free , RoHS and REACH compliant

Applications

- Keypad backlighting
- Push-button and switch backlighting
- LCD backlighting
- Symbol backlighting
- Front-panel indicator
- Optical indicator
- Home and smart appliances
- Wearable and portable devices
- Toys
- Displays for industrial control systems

Rev-4

Package Drawing



Note:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.1 mm unless otherwise specified.

Part Table									
#	Part Number	Emission Color	Polarity	Znener	Binning Current (mA)	Luminous Intensity (mcd)	Dominant Wavelength (nm)	Forward Voltage (V)	Remark
1	YY0805RE-NN1S0-T3AR4	Red			5	28-70	615-630	1.8-2.4	
2	YY0805RE-NN2S0-T3AR4	Red			10	48-120	615-630	1.8-2.4	
3	YY0805RE-NN3S0-T3AR4	Red			20	120-300	615-630	1.8-2.4	
4	YY0805RE-NZ3S0-T3AR4	Red		available	20	120-250	615-630	1.8-2.4	
5	YY0805RE-NN3S1-T3AR4	Red			20	58-145	627-636	1.8-2.4	Higher Wavelength
6	YY0805RE-NZ3S1-T3AR4	Red		available	20	58-145	627-636	1.8-2.4	Higher Wavelength
7	YY0805RE-RN3S0-T3AR4	Red	Reverse		20	210-430	615-630	1.8-2.4	
8	YY0805RE-RN3S1-T3AR4	Red	Reverse		20	175-360	627-636	1.8-2.4	Higher Wavelength

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Absolute Maximum Ratings for at Ta = 25°C

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V _R	5	V	
Forward Current	I _F	20	mA	
Peak Forward Current(Duty 1/10 @1KHz)	I _{FP}	60	mA	
Power Dissipation	Pd	48	mW	
Electrostatic Discharge	ESD _{HBM}	> 2000	V	
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	°C	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec.		
		Hand Soldering : 300 °C for 3 sec.		

Luminous Intensity (Iv) Bin Limits

Bin ID	Luminous Intensity(mcd)		
	Min.	Max.	
P13	24	28	
P14	28	24	
P15	34	40	
P16	48	58	
P17	58	70	
P18	70	85	
P19	85	100	
P20	100	120	
P21	120	145	
P22	145	175	
P23	175	210	
P24	210	250	
P25	250	300	
P26	300	360	
P27	360	430	
P28	430	520	

Forward Voltalge(V) Bin Limits

Bin ID	Forward Voltage(V)			
	Min.	Max.		
VE	1.8	1.9		
VF	1.9	2.0		
VG	2.0	2.1		
VH	2.1	2.2		
VI	2.2	2.3		
VJ	2.3	2.4		

Dominant Wavelength (nm) Bin Limits

Bin ID	Dominant Wavelength (nm)			
BIITID	Min.	Max.		
R1	615	618		
R2	618	621		
R3	621	624		
R4	624	627		
R5	627	630		

* Tolerance of measurement of luminous intensity is ±10%.

* Tolerance of measurement of forward voltage is ±0.05V.

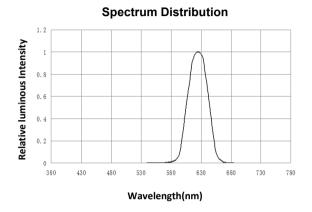
* Tolerance of measurement of dominant wavelength is ± 1 nm.

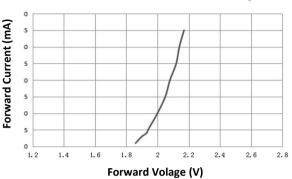
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Surface Mount ChipLEDs

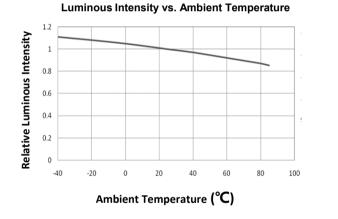
TYPICAL ELECTRO-OPTICAL CHARATERISTICS CURES(Ta=25°C)

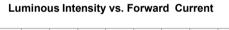
The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

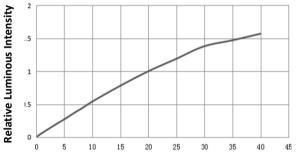




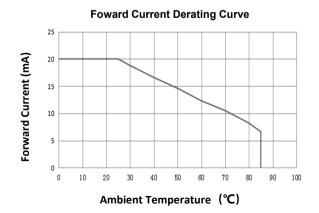
Forward Current vs. Foward Voltage



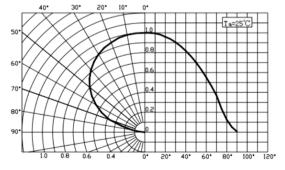




Forward Current (mA)



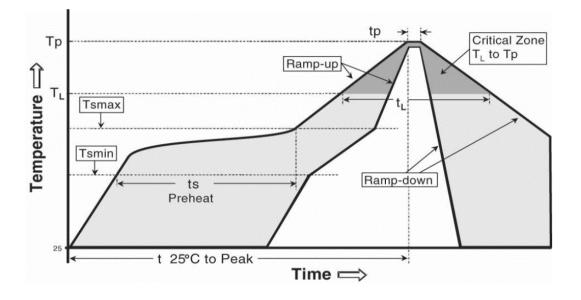




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REFLOW SOLDERING

- The ChipLED is rated as a MSL3 as general request product.
- The recommended floor life out of bag is 24hrs.
- The temperature profile is as below.



IPC/JEDEC J-STD-020C

Profile Feature	Pb-Free Assembly
Average ramp-up rate(Tsmax to Tp)	3°C/second max.
Preheat	
- Temperature Min(Ts _{min})	150°C
- Temperature Max(Ts _{max})	200°C
- Time(Tsmin to Ts _{max})	60-180 seconds
Time mainted above	
- Temperature(T _L)	217°C
- Time(T _L)	60-150 seconds
Peak Temperature(Tp)	260° ℃
Time within 5°C of actual peak Temperature(tp) ²	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to peak Temperature	8 minutes max.

Moisture Sensitivity

• Yongyu recommends keeping ChipLEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain ChipLEDs do not need special storage for moisture sensitivity.

• Once the MBP is opened, ChipLEDs may be stored as MSL 3 per IPC/JEDEC J-STD-020C, meaning they have one year of floor life in conditions of \leq 30 °C/60% relative humidity (RH). Regardless of the storage condition, Yongyu LED recommends sealing any unsoldered ChipLEDs in the original MBP.

Handling

• The packaging sizes of these SMD products are very small. Users are required to handle with care.

• To avoid damaging the product's surface and interior device, it is recommended to choose a special nozzle to pick up the SMD products during the process of SMT production. If handling is necessary, take special care when picking up these products.

Repairing

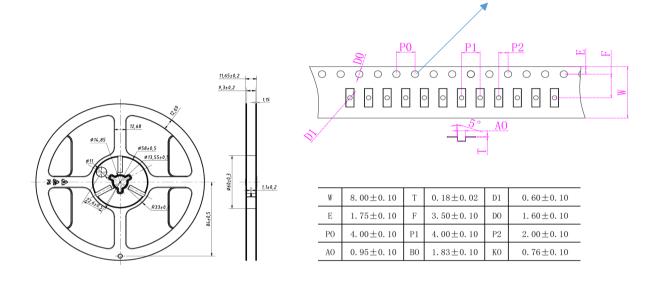
Repair should not be recommended after SMT production. When repairing is needed, a double-head soldering iron should be used (as below figure). It should be assured before handing whether the electrical and optical characteristics of the LEDs will or will not be damaged by repairing.

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Cathode Mark

PACKING

- The LEDs are packed in cardboard boxes after packaging in normal or anti-electrostatic bags.
- Cardboard boxes will be used to protect the LEDs from mechanical shock during transportation.
- The boxes are not water resistant, and they must be kept away from water and moisture.
- The reel pack is applied in SMD LED.
- 3000pcs per reel.





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